

Features

- ☐ 32768x8 bit static CMOS RAM
- ☐ Access times 70 ns, 100 ns
- ☐ Common data inputs and data outputs
- ☐ Three-state outputs
- ☐ Typ. operating supply current
 - 70 ns: 50 mA
 - 100 ns: 40 mA
- ☐ TTL/CMOS-compatible
- ☐ Automatical reduction of power dissipation in long Read Cycles
- ☐ Power supply voltage $5\text{ V} \pm 10\%$
- ☐ Operating temperature ranges
 - 0 to 70 °C
 - 40 to 85 °C
 - 40 to 125 °C
- ☐ QS 9000 Quality Standard
- ☐ ESD protection > 2000 V (MIL STD 883C M3015.7)
- ☐ Latch-up immunity >100 mA
- ☐ Packages: PDIP28 (600 mil)
SOP28 (330 mil)

Description

The U62256A is a static RAM manufactured using a CMOS process technology with the following operating modes:

- Read
- Standby
- Write
- Data Retention

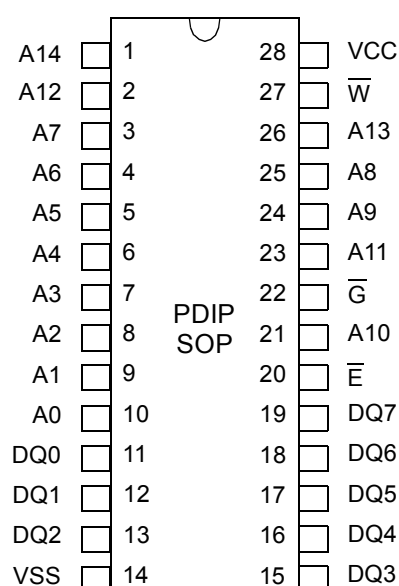
The memory array is based on a 6-transistor cell.

The circuit is activated by the falling edge of $\overline{E}$. The address and control inputs open simultaneously. According to the information of $\overline{W}$ and $\overline{G}$, the data inputs, or outputs, are active. In a Read cycle, the data outputs are activated by the falling edge of $\overline{G}$, afterwards the data word read will be available at the outputs DQ0-DQ7. After the address change, the data outputs go High-Z until the new information read is available. The data outputs have not preferred state. The Read cycle is finished by the

falling edge of $\overline{W}$, or by the rising edge of $\overline{E}$, respectively.

Data retention is guaranteed down to 2 V. With the exception of $\overline{E}$, all inputs consist of NOR gates, so that no pull-up/pull-down resistors are required.

Pin Configuration



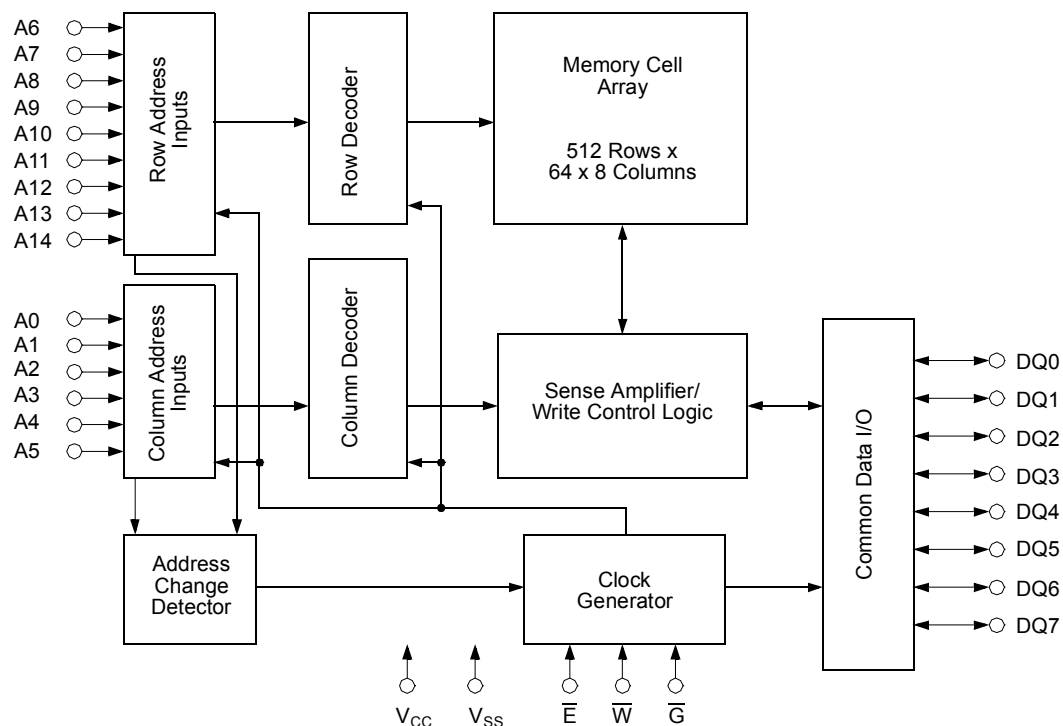
Top View

Pin Description

Signal Name	Signal Description
A0 - A14	Address Inputs
DQ0 - DQ7	Data In/Out
$\overline{E}$	Chip Enable
$\overline{G}$	Output Enable
$\overline{W}$	Write Enable
VCC	Power Supply Voltage
VSS	Ground

U62256A

Block Diagram



Truth Table

Operating Mode	$\bar{E}$	$\bar{W}$	$\bar{G}$	DQ0 - DQ7
Standby/not selected	H	*	*	High-Z
Internal Read	L	H	H	High-Z
Read	L	H	L	Data Outputs Low-Z
Write	L	L	*	Data Inputs High-Z

* H or L

Characteristics

All voltages are referenced to $V_{SS} = 0\text{ V}$ (ground).

All characteristics are valid in the power supply voltage range and in the operating temperature range specified.

Dynamic measurements are based on a rise and fall time of $\leq 5\text{ ns}$, measured between 10 % and 90 % of V_i , as well as input levels of $V_{IL} = 0\text{ V}$ and $V_{IH} = 3\text{ V}$. The timing reference level of all input and output signals is 1.5 V, with the exception of the t_{dis} -times and t_{en} -times, in which cases transition is measured $\pm 200\text{ mV}$ from steady-state voltage.

Absolute Maximum Ratings ^a		Symbol	Min.	Max.	Unit
Power Supply Voltage		V_{CC}	-0.5	7	V
Input Voltage		V_I	-0.5	$V_{CC} + 0.5$ ^b	V
Output Voltage		V_O	-0.5	$V_{CC} + 0.5$ ^b	V
Power Dissipation		P_D	-	1	W
Operating Temperature	C-Type	T_a	0	70	°C
	K-Type		-40	85	
	A-Type		-40	125	
Storage Temperature	C/K-Type	T_{stg}	-65	125	°C
	A-Type		-65	150	
Output Short-Circuit Current at $V_{CC} = 5\text{ V}$ and $V_O = 0\text{ V}$ ^c		$ I_{OS} $		200	mA

^a Stresses greater than those listed under „Absolute Maximum Ratings“ may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at condition above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability

^b Maximum voltage is 7 V

^c Not more than 1 output should be shorted at the same time. Duration of the short circuit should not exceed 30 s.

Recommended Operating Conditions	Symbol	Conditions	Min.	Max.	Unit
Power Supply Voltage	V_{CC}		4.5	5.5	V
Input Low Voltage ^d	V_{IL}		-0.3	0.8	V
Input High Voltage	V_{IH}		2.2	$V_{CC} + 0.3$	V

^d -2 V at Pulse Width 10 ns

U62256A

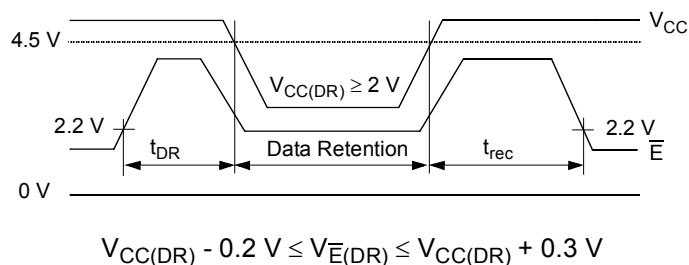
Electrical Characteristics	Symbol	Conditions	Min.	Max.	Unit
Supply Current - Operating Mode	$I_{CC(OP)}$	$V_{CC} = 5.5 \text{ V}$ $V_{IL} = 0.8 \text{ V}$ $V_{IH} = 2.2 \text{ V}$ $t_{cW} = 70 \text{ ns}$ $t_{cW} = 100 \text{ ns}$		70 65	mA mA
Supply Current - Standby Mode (CMOS level)	$I_{CC(SB)}$	$V_{CC} = 5.5 \text{ V}$ $V_{\bar{E}} = V_{CC} - 0.2 \text{ V}$ C-Type K-Type A-Type		5 10 50	μA μA μA
Supply Current - Standby Mode (TTL level)	$I_{CC(SB)1}$	$V_{CC} = 5.5 \text{ V}$ $V_{\bar{E}} = 2.2 \text{ V}$		1	mA
Output High Voltage	V_{OH}	$V_{CC} = 4.5 \text{ V}$ $I_{OH} = -1.0 \text{ mA}$	2.4		V
Output Low Voltage	V_{OL}	$V_{CC} = 4.5 \text{ V}$ $I_{OL} = 3.2 \text{ mA}$		0.4	V
Input High Leakage Current	I_{IH}	$V_{CC} = 5.5 \text{ V}$ $V_{IH} = 5.5 \text{ V}$		2	μA
Input Low Leakage Current	I_{IL}	$V_{CC} = 5.5 \text{ V}$ $V_{IL} = 0 \text{ V}$	-2		μA
Output High Current	I_{OH}	$V_{CC} = 4.5 \text{ V}$ $V_{OH} = 2.4 \text{ V}$		-1	mA
Output Low Current	I_{OL}	$V_{CC} = 4.5 \text{ V}$ $V_{OL} = 0.4 \text{ V}$	3,2		mA
Output Leakage Current High at Three-State Outputs	I_{OHZ}	$V_{CC} = 5.5 \text{ V}$ $V_{OH} = 5.5 \text{ V}$		1	μA
Low at Three-State Outputs	I_{OLZ}	$V_{CC} = 5.5 \text{ V}$ $V_{OL} = 0 \text{ V}$	-1		μA

Switching Characteristics Read Cycle	Symbol		07		10		Unit
	Alt.	IEC	Min.	Max.	Min.	Max.	
Read Cycle Time	t_{RC}	t_{cR}	70		100		ns
Address Access Time to Data Valid	t_{AA}	$t_{a(A)}$		70		100	ns
Chip Enable Access Time to Data Valid	t_{ACE}	$t_{a(E)}$		70		100	ns
Output Enable Access Time to Data Valid	t_{OE}	$t_{a(G)}$		35		45	ns
$\bar{E}$ HIGH to Output in High-Z	t_{HZCE}	$t_{dis(E)}$		25		35	ns
$\bar{G}$ HIGH to Output in High-Z	t_{HZOE}	$t_{dis(G)}$		25		35	ns
$\bar{E}$ LOW to Output in Low-Z	t_{LZCE}	$t_{en(E)}$	5		5		ns
$\bar{G}$ LOW to Output in Low-Z	t_{LZOE}	$t_{en(G)}$	0		0		ns
Output Hold Time from Address Change	t_{OH}	$t_{v(A)}$	5		5		ns

Switching Characteristics Write Cycle	Symbol		07		10		Unit
	Alt.	IEC	Min.	Max.	Min.	Max.	
Write Cycle Time	t_{WC}	t_{cW}	70		100		ns
Write Pulse Width	t_{WP}	$t_{w(W)}$	55		70		ns
Write Pulse Width Setup Time	t_{WP}	$t_{su(W)}$	55		70		ns
Address Setup Time	t_{AS}	$t_{su(A)}$	0		0		ns
Address Valid to End of Write	t_{AW}	$t_{su(A-WH)}$	65		80		ns
Chip Enable Setup Time	t_{CW}	$t_{su(E)}$	65		80		ns
Pulse Width Chip Enable to End of Write	t_{CW}	$t_{w(E)}$	65		80		ns
Data Setup Time	t_{DS}	$t_{su(D)}$	30		35		ns
Data Hold Time	t_{DH}	$t_{h(D)}$	0		0		ns
Address Hold from End of Write	t_{AH}	$t_{h(A)}$	0		0		ns
$\bar{W}$ LOW to Output in High-Z	t_{HZWE}	$t_{dis(W)}$		25		35	ns
$\bar{G}$ HIGH to Output in High-Z	t_{HZOE}	$t_{dis(G)}$		25		35	ns
$\bar{W}$ HIGH to Output in Low-Z	t_{LZWE}	$t_{en(W)}$	0		0		ns
$\bar{G}$ LOW to Output in Low-Z	t_{LZOE}	$t_{en(G)}$	0		0		ns

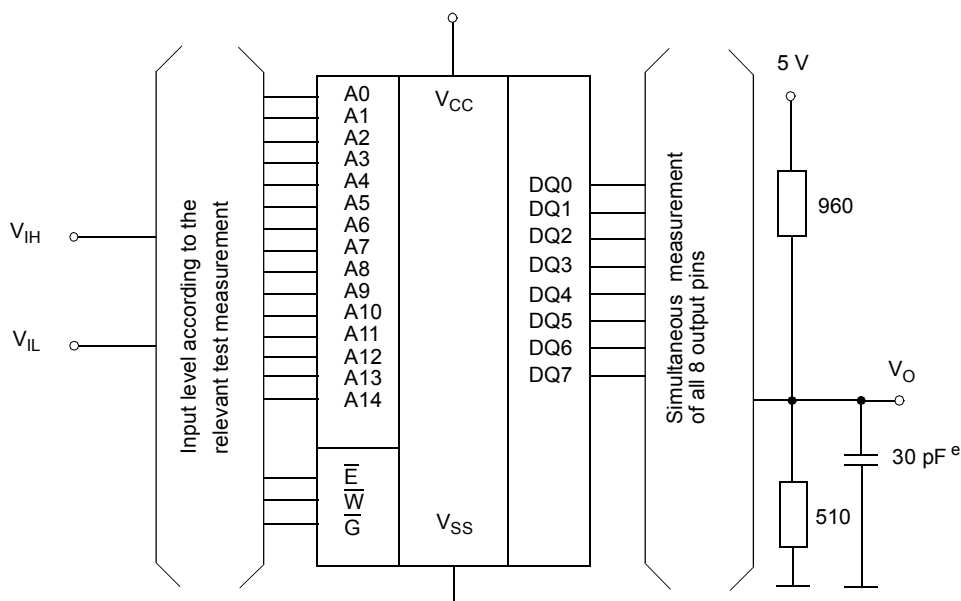
Data Retention Mode

$\bar{E}$ -Controlled



Data Retention Characteristics	Symbol Alt. IEC	Conditions	Min.	Typ.	Max.	Unit
Data Retention Supply Voltage	$V_{CC(DR)}$		2		5.5	V
Data Retention Supply Current	$I_{CC(DR)}$	$V_{CC(DR)} = 3\text{ V}$ $V_{\bar{E}} = V_{CC(DR)} - 0.2\text{ V}$ C-Type K-Type A-Type			3 6 30	μA μA μA
Data Retention Setup Time	t_{CDR}	$t_{su(DR)}$	0			ns
Operating Recovery Time	t_R	t_{rec}	t_{cR}			ns

Test Configuration for Functional Check



^e In measurement of $t_{dis(E)}$, $t_{dis(W)}$, $t_{dis(G)}$, $t_{en(E)}$, $t_{en(W)}$, $t_{en(G)}$ the capacitance is 5 pF.

Capacitance	Conditions	Symbol	Min.	Max.	Unit
Input Capacitance	$V_{CC} = 5.0\text{ V}$ $V_I = V_{SS}$	C_I	-	7	pF
Output Capacitance	$f = 1\text{ MHz}$ $T_a = 25\text{ °C}$	C_O	-	7	pF

All pins not under test must be connected with ground by capacitors.

Ordering Code

Example

U62256A S2 K 07 LL

Type

Package

D = PDIP28 (600 mil, only C/K-Type and 70 ns)
S2 = SOP28 (330 mil) Type 2

Operating Temperature Range

C = 0 to 70 °C
K = -40 to 85 °C
A = -40 to 125 °C

Access Time

07 = 70 ns
10 = 100 ns (only C/K-Type)

Leadfree Option

blank = Standard Package

G1 = Leadfree Green Package ^f

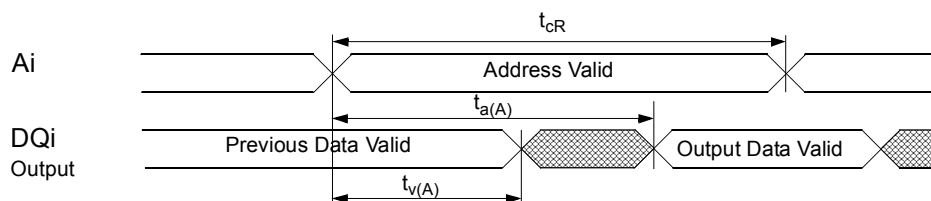
Power Consumption

blank = Standard (only A-Type)

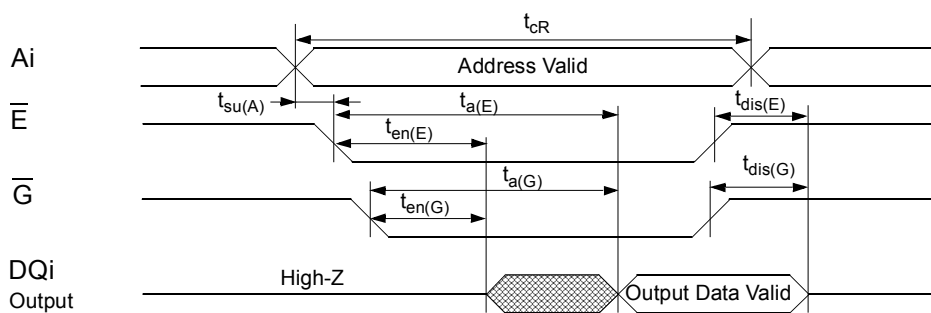
LL = Very Low Power (C/K-Type)

^f on special request

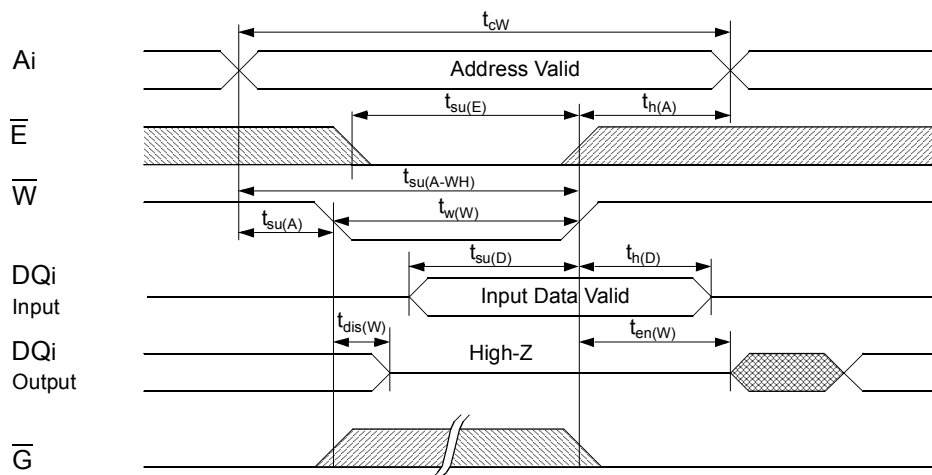
Read Cycle 1: Ai-controlled (during Read Cycle : $\overline{E} = \overline{G} = V_{IL}$, $\overline{W} = V_{IH}$)



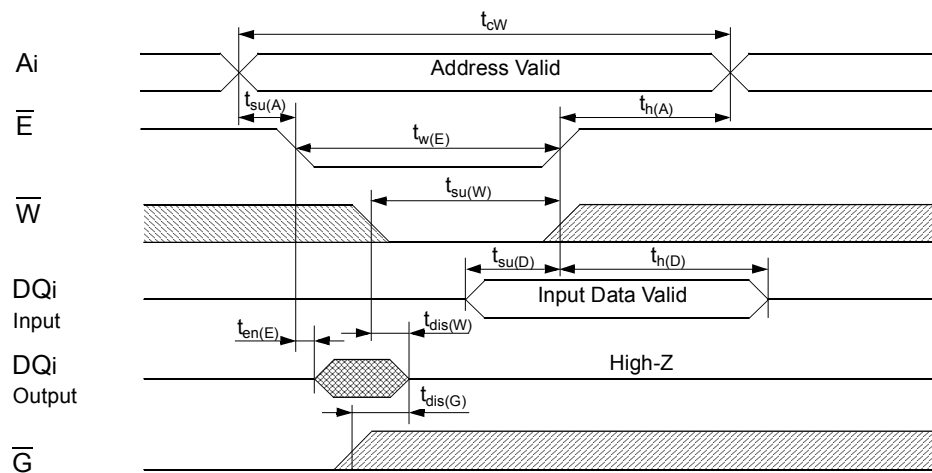
Read Cycle 2: $\overline{G}$ -, $\overline{E}$ -controlled (during Read Cycle: $\overline{W} = V_{IH}$)



Write Cycle1: $\overline{W}$ -controlled



Write Cycle 2: $\overline{E}$ -controlled



undefined  L- to H-level  H- to L-level 

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